



NOTES:

1. ALL EXPOSED METALLIZED AREA SHALL BE GOLD PLATED 80 MICRO INCH MIN. THK. OVER Cu PLATED 50-350 MICRO INCH.
2. FLATNESS METALLIZED PADS ONLY.
3. SEAL AREA AND DIE ATTACH AREA SHALL BE ISOLATED FROM ANY LEADS.(ZERO GROUND)
4. INTERNAL PATTERN DESIGN IS VENDOR'S OPTION.
5. KYOCERA STANDARD SPEC AS-1003-B SHALL BE APPLIED EXCEPT FOR ITEM2 (BAKING TEST).
a) BAKING TEST;
GOLD PLATING SHALL NOT SHOW BLISTERS, PEELING OR FLAKING, WHEN VIEWED BY NAKED EYE AFTER BAKING TEST USING HEATER BLOCK AT 350 DEGREE C FOR 1 MINUTE IN AIR ATMOSPHERE. DISCOLORATION OF GOLD PLATING SHALL BE ACCEPTABLE.
6. THIS PACKAGE CONSIST OF "NOT FERROMAGNETISM MATERIAL", WHICH ARE DIAMAGNETISM, PARAMAGNETIC AND ANTIFERROMAGNETIC MATERIALS, WHICH DOESN'T NECESSARILY MEAN ZERO TESLA.

MODIFICATIONS				NAME	TOLERANCES	DRAWN	CHECKED	APPROVED	SHEET
CHANGE				44 LCC (.474 SQ. CAV.)	UNLESS OTHERWISE SPECIFIED	H.S	S.S/M.Y	M.T	1/1
				SCALE 10/1	MATERIAL KYOCERA A440				
						DRAWING NO. PB-CB8121			
					KYOCERA CORPORATION KYOTO JAPAN				

